

Maximum Ratings (@T_A = 25°C, unless otherwise specified.)

Characteristic		Symbol	BAS19	BAS20	BAS21	Unit
Repetitive Peak Reverse Voltage		V _{RRM}	120	200	250	V
Working Peak Reverse Voltage DC Blocking Voltage		V _{RWM} V _R	100	150	200	V
RMS Reverse Voltage		V _{R(RMS)}	71	106	141	V
Forward Continuous Current (Note 6)		I _{FM}	400			mA
Average Rectified Output Current (Note 6)		lo	200			mA
Non-Repetitive Peak Forward Surge Current	@ t = 1.0µs @ t = 1.0s	I _{FSM}	2.5 0.5		А	
Repetitive Peak Forward Surge Current (Note 6)		I _{FRM}	625			mA

Thermal Characteristics

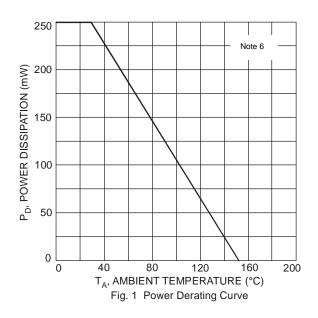
Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6)	PD	250	mW
Thermal Resistance Junction to Ambient Air (Note 6)	$R_{ heta JA}$	500	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

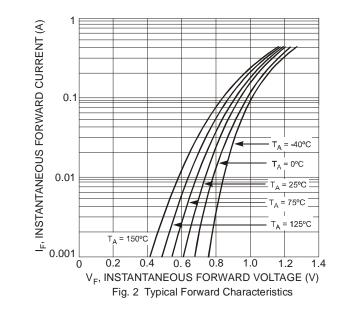
Electrical Characteristics (@T_A = 25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Max	Unit	Test Condition		
Reverse Breakdown Voltage (Note 7)	BAS19 BAS20 BAS21	V _{(BR)R}	120 200 250	_	V	I _R = 100μA	
Forward Voltage		VF	_	1.0 1.25	V	I _F = 100mA I _F = 200mA	
Reverse Current @ Rated DC Blocking Voltage (Note 7)		I _R	_	100 15	nΑ μΑ	$T_{J} = 25^{\circ}C$ $T_{J} = 100^{\circ}C$	
Total Capacitance		Ст		5.0	pF	$V_{R} = 0, f = 1.0MHz$	
Reverse Recovery Time		t _{rr}		50	ns	$I_F = I_R = 30 \text{mA},$ $I_{rr} = 0.1 \times I_R, R_L = 1009$	

Notes: 6. Part mounted on FR-4 board with recommended pad layout, which can be found on our website at http://www.diodes.com. I_{FM, Io} are valid provided that terminals are kept at ambient temperature.

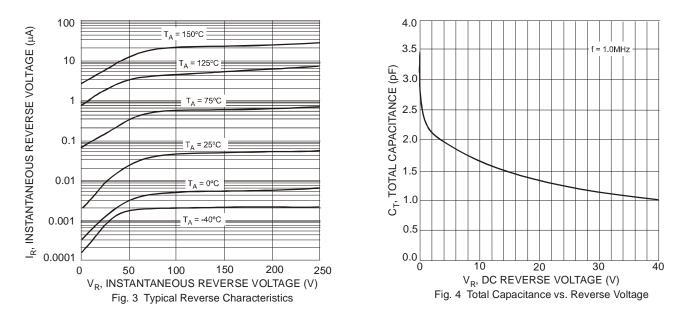
Short duration pulse test used to minimize self-heating effect.





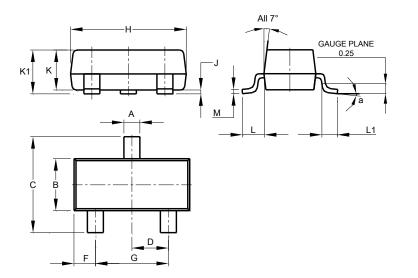


BAS19 / BAS20 / BAS21



Package Outline Dimensions

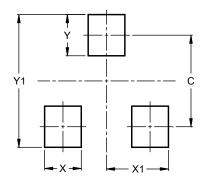
Please see http://www.diodes.com/package-outlines.html for the latest version.



SOT23					
Dim	Min	Max	Тур		
Α	0.37	0.51	0.40		
В	1.20	1.40	1.30		
С	2.30	2.50	2.40		
D	0.89	1.03	0.915		
F	0.45	0.60	0.535		
G	1.78	2.05	1.83		
Н	2.80	3.00	2.90		
J	0.013	0.10	0.05		
K	0.890	1.00	0.975		
K1	0.903	1.10	1.025		
L	0.45	0.61	0.55		
L1	0.25	0.55	0.40		
Μ	0.085	0.150	0.110		
а	0°	8°			
All Dimensions in mm					

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



BAS19 / BAS20 / BAS21 Document number: DS12004 Rev. 22 - 2 Downloaded from Arrow.com.

Dimensions	Value (in mm)		
С	2.0		
Х	0.8		
X1	1.35		
Y	0.9		
Y1	2.9		



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